

02N50

UTC UNISONIC TECHNOLOGIES CO., LTD

Preliminary

Power MOSFET

0.2A, 500V N-CHANNEL **POWER MOSFET**

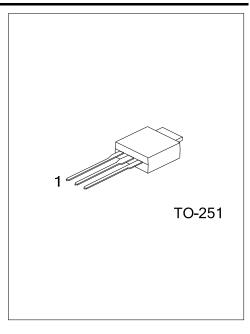
DESCRIPTION

The UTC 02N50 is an N-channel MOSFET, it uses UTC's advanced technology to provide the customers with high breakdown voltage

FEATURES

* R_{DS(on)}=75Ω @V_{GS}=10V, I_D=0.15A

* High breakdown voltage



ORDERING INFORMATION

Ordering Number		Daakaga	Pin Assignment			Decking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
02N50L-TM3-T	02N50L-TM3-T 02N50G-TM3-T		G	D	S	Tube	
Note: Pin Assignment: G: Gate D: Drain S: Source							
	(1) T: Tube (2) TM3: TO-2! (3) L: Lead Fre		logen Fr	ee			

m 21 p
K W CON
11-7F3 680.
A LA LA
and the second
- FUSAN TIS
A NINNY
4 4 70
www.unisonic.com.tw
Copyright © 2010 Unisonic Technologies Co., Ltd

ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	500	V
Gate-Source Voltage		V _{GSS}	±30	V
Drain Current	Continuous	I _D	0.2	А
	Pulsed	I _{DM}	1	А
Avalanche Current (Note 1)		I _{AR}	0.2	А
Power Dissipation		P _D	40	W
Junction Temperature		TJ	150	°C
Storage Temperature Range		T _{STG}	-55 ~+150	С°

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

ELECTRICAL CHARACTERISTICS

			1		i	1	
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	500			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =500V, V _{GS} =0V, T _A =25°C			10	μA
Gate-Source Leakage Current	Forward		V _{GS} =+30V, V _{DS} =0V			+100	nA
	Reverse	I _{GSS}	V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250µA			4.5	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =0.15A, T _A =25°C		62	75	Ω
DYNAMIC PARAMETERS							
nput Capacitance		CISS			200		рF
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		20		рF
Reverse Transfer Capacitance			1 Γ		8		рF
SWITCHING PARAMETERS							
Total Gate Charge		Q_{G}			3.0	4.5	nC
Gate to Source Charge		Q_{GS}	V _{GS} =10V, I _D =0.2A, V _{PS} =400V		0.45	0.7	nC
Gate to Drain Charge		Q_{GD}			0.4	0.75	nC
Turn-ON Delay Time		t _{D(ON)}			9		ns
Rise Time		t _R			4		ns
Turn-OFF Delay Time		t _{D(OFF)}	V_{DD} =250V, I_{D} =0.2A, R_{G} =25 Ω		28		ns
Fall-Time		t _F			45		ns
SOURCE- DRAIN DIODE RATII	NGS AND O	CHARACTER	ISTICS				
Maximum Body-Diode Continuous Current		ls				0.2	Α
Maximum Body-Diode Pulsed Current		I _{SM}				1	Α
Drain-Source Diode Forward Voltage		V _{SD}	I _S =0.2A, V _{GS} =0V			1	V

UNISONIC TECHNOLOGIES CO., LTD

UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice.

